

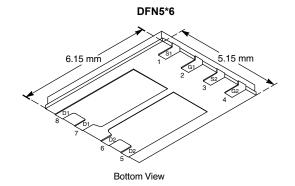
SI7844DP-VB Datasheet Dual N-Channel 30 V (D-S) MOSFET

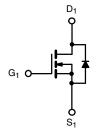
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
30	0.018 at V _{GS} = 10 V	22		

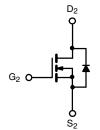
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC









N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 20		V	
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	1	22		۸	
Continuous Diam Current (1, = 150 C)	T _A = 70 °C	- I _D	15			
Pulsed Drain Current		I _{DM}	50		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	2.9			
Maximum Power Dissipation ^a	T _A = 25 °C	D.	3.5		W	
Maximum Fower Dissipation	T _A = 70 °C	P _D				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	5 to 150	°C	
Soldering Recommendations (Peak Temperature)			260		C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marine and Landing to Austriant	t ≤ 10 s	В	26	35	
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	60	85	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	3.9	5.5	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

服务热线:400-655-8788

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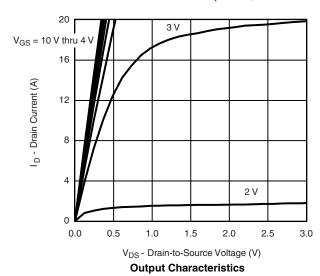
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.8		2.4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current		V _{DS} = 30 V, V _{GS} = 0 V	V _{DS} = 30 V, V _{GS} = 0 V		1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	_	V _{GS} = 10 V, I _D = 10 A		0.018			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 8.5 \text{ A}$		0.024		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		22		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.75	1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			13	20		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		2		nC	
Gate-Drain Charge	Q_{gd}			2.7			
Gate Resistance	R_g		0.5		3.2	Ω	
Turn-On Delay Time	t _{d(on)}			8	16		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		10	20	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		21	40		
Fall Time	t _f			10	20		
Source-Drain Reverse Recovery Time t _{rr}		I _F = 2.9 A, dI/dt = 100 A/μs		40	80		

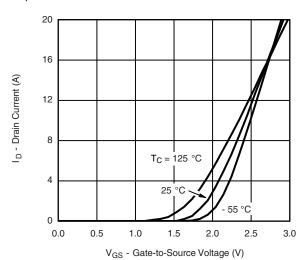
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

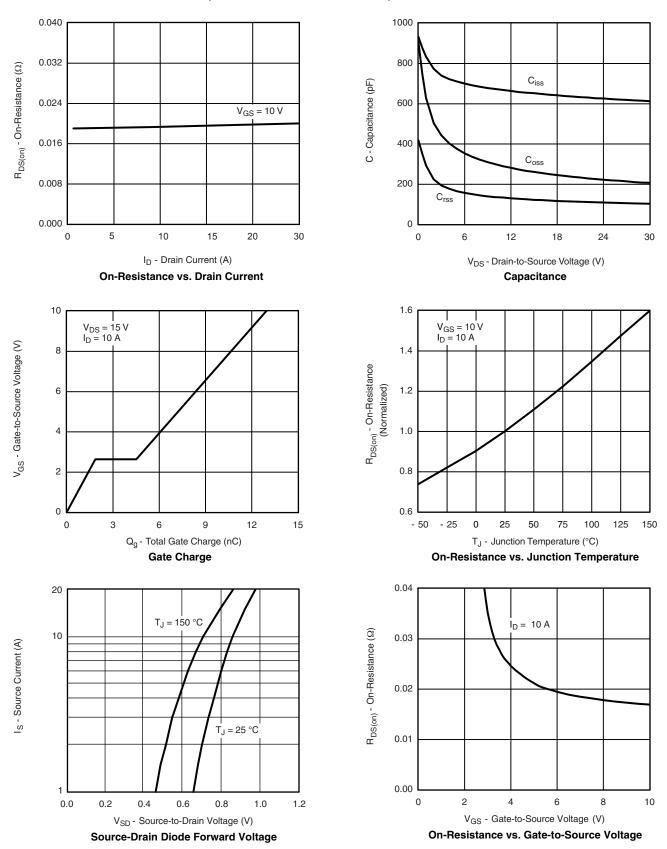




Transfer Characteristics

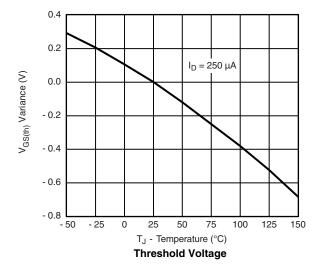


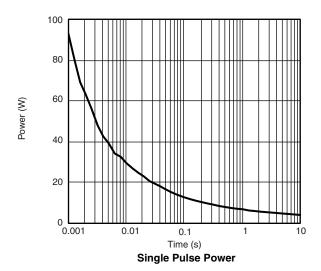
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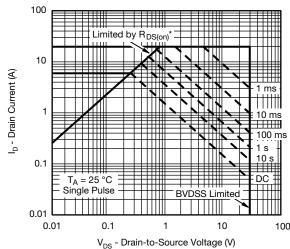


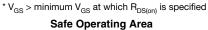


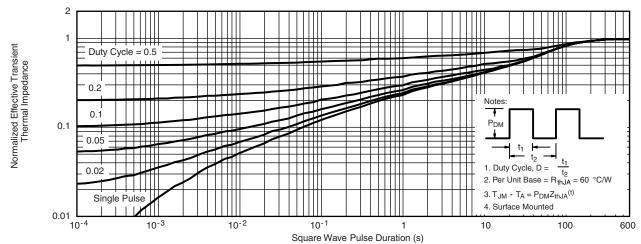
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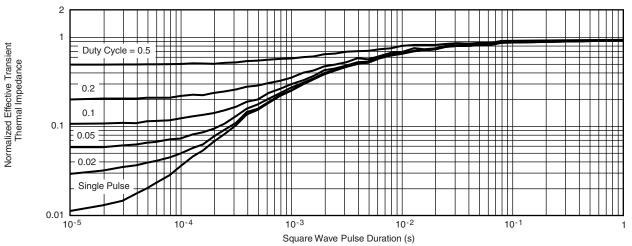




Normalized Thermal Transient Impedance, Junction-to-Ambient



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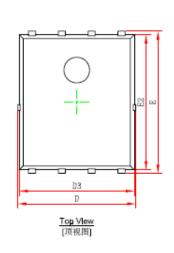


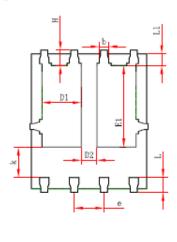
Normalized Thermal Transient Impedance, Junction-to-Case



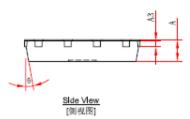
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PDFNWB5×6-8L-A PACKAGE OUTLINE DIMENSIONS





Bottom View [背视图]



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010REF.		
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	1.470	1.870	0.058	0.074	
D2	0.470	0.870	0.019	0.034	
E1	3.375	3.575	0.133	0.141	
D3	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270TYP.		0.050TYP.		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	



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